# Logan Kaminski

f/k/a David Logan Cummings

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#### **EDUCATION**

May 2007

Bachelor of Science Johns Hopkins University **Electrical and Computer Engineering** Baltimore, MD

## EXPERIENCE

July 2016 - Nov. 2023

Senior Applications Engineer

## Linear Technology

Grass Valley, CA

• Supported customers as factory applications working together with IC designers.

Aug. 2015 - June 2016

Senior Hardware Engineer

#### Airware

San Francisco, CA

- Owned development of a SWaP constrained aerial compute platform from requirements finalization through DVT
- FCC and CE testing of a complete commercial UAV
- Developed and supported production testing of all hardware components of the Aerial Information Platform

July 2014 - July 2015

Hardware Engineer

#### Airware

San Francisco, CA

- Schematic revision, prototyping, board bring-up and DVT for multiple small embedded sensor systems
- EMI troubleshooting and mitigation for a sensitive GNSS receiver board

Sept. 2013 - June 2014

Staff Engineer

## Talksum, Inc.

Campbell, CA

- Developed a custom embedded Linux targeting x86\_64 and ARM SoCs in under 150MB using BusyBox, crosstool-NG, and Buildroot: single userspace codebase supported without modification on all platforms
- Led the design and development of a full-system testing suite
- Wrote requirements and specifications for 1/3 of initial release tasks

Nov. 2011 - Aug. 2013

Co-Founder

#### Sensorstar Labs

Long Island City, NY

- Designed and built an audio-synchronized 64-channel LED controller
- Novel biometrics sensor circuit design and prototyping
- Schematic capture and PCB layout for a very small wearable Bluetooth
- Aided in the development and testing of a virtual world conferencing application utilizing OpenCV for background segmentation

Nov. 2010 - Sept. 2011

Consulting Senior Engineer

#### Sensorstar, Inc.

Ellicott City, MD

- System architecture, power supply design, and team lead for a portable multi-mode wireless communications and data acquisition device
- Circuit analysis and debug for a high-speed audio interleaving system
- Android application testing and development

Oct. 2008 - Oct. 2010 | Systems Architect

#### Northrop Grumman ES

Linthicum, MD

• Evaluation and selection of mainstream-market driven high performance coprocessors – including algorithm work in C, VHDL, and CUDA

# SKILLS

Schematic Capture & PCB Layout

Altium Designer, CadSoft Eagle

Computer Languages 3D CAD

C, C++, Python, Bash, OpenCV, Ruby, LATEX, inter alia as needed Dassault Solidworks, PTC Creo (formerly Pro/ENGINEER) SPICE (LTSpice, Berkeley 3f5), Solidworks Mechanical

Simulation Operating Systems Fabrication Human Languages

Linux (Ubuntu pref., Embedded via Buildroot), OS X, Windows XP/7/10 3D Printing, Welding (TIG, MIG, Stick), Machining (Manual and CNC)

Native English, Conversational Spanish

## PATENT APPLICATIONS

Automotive Seating

Montgomery, Benson, Cummings, Drubetskoy, Bonk

Oximetry Sensor Assembly and Methodology for Sensing Blood Oxygen Concentration

US Application # 20150297125 filed Nov. 26 2013

Benson, Lowell, Montgomery, Dexter, Bonk, Cummings, Haase, Baudu, Boussetta, Drubetskoy, Dacosta-Mallet

Vehicle Seat with Integrated Sensors

US Application # 20150313475 filed Nov. 25 2013

## LINKS

Github | https://github.com/realpsyence

LinkedIn https://www.linkedin.com/in/logan-cummings-9682ba5